Product Change Notification

Change Notification #: 116801 - 00

Change Title: Intel® Wireless-AC8265 2230 SKUs: 8265.NGWMG, 8265.NGWMG.NV, 8265.NGWMG.S, 8265.NGWMG.NVS, 8265.NGWMG.K, 8265.NGWMG.NVK, 8265.NGWMG.DTX1, PCN 116801-00, Label, Label Updates

Date of Publication: March 04, 2019

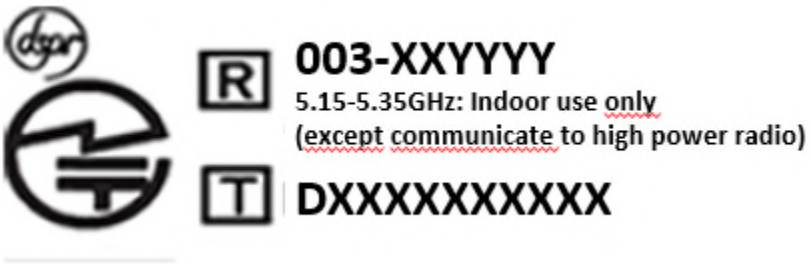
Key Characteristics of the Change:
Label

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:	March 25, 2019

Description of Change to the Customer:
The Intel® Wireless-AC8265 2230 SKUs listed in the products affected table below will undergo the following changes

1. Update Japan Regulatory marking per below:



2. The Intel Tracking revision will be changed on the following products

SKU	Before (CN)	After (CN)
8265.NGWMG	0G	OH
8265.NGWMG.NV	0G	0H
8265.NGWMG.DTX1	0G	0H

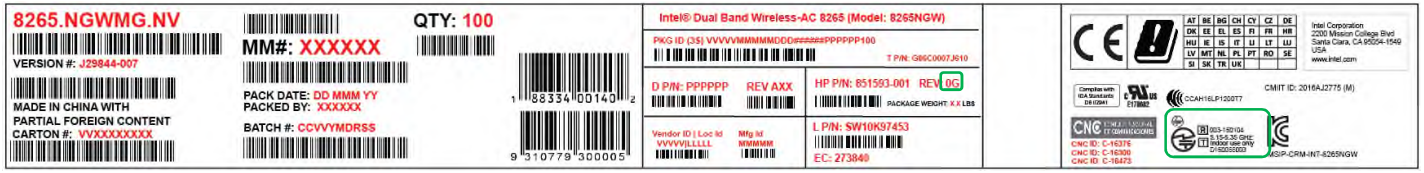
Product Code	PROD Label (Before)
8265.NGWMG	
	PROD Label (After)
	DISTI Label (Before)
	DISTI Label (After)

8265.NGWMG.NV

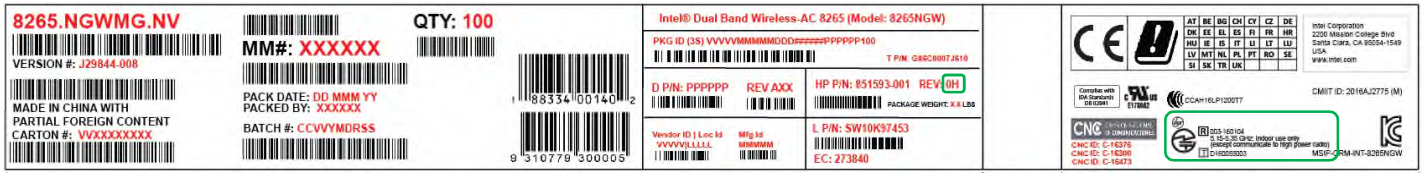
PROD Label (Before)

PROD Label (After)

DISTI Label (Before)



DISTI Label (After)

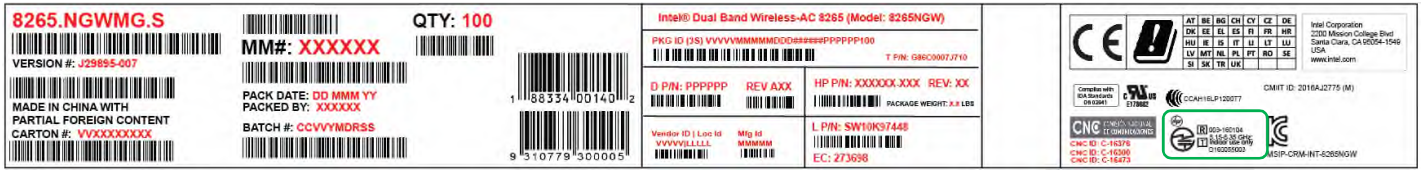


8265.NGWMG.S

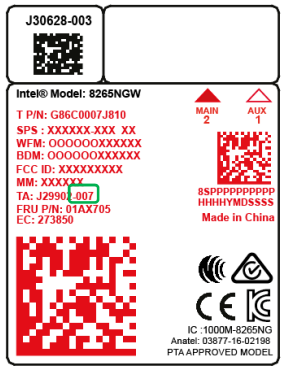
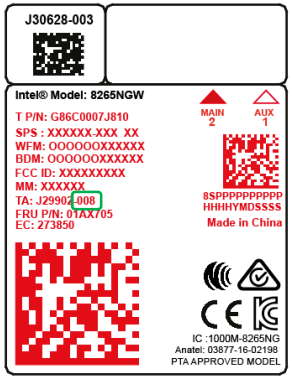
PROD Label (Before)

PROD Label (After)

DISTI Label (Before)



DISTI Label (After)

8265.NGWMG.NVS	**PROD Label (Before)**  J30628-003 Intel® Model: 8265NGW T P/N: G86C0007J810 SPS : XXXXXX-XXX XX WFM: OOOOOOXXXXXX BDM: OOOOOOXXXXXX FCC ID: XXXXXXXXX MM: XXXXXX TA: J29902-007 FRU P/N: 01AX705 EC: 273850 MAIN 2 AUX 1 8SPPPPPPPPPP HHHHYMDSSSS Made in China IC :1000M-8265NG Anatel: 03877-16-02198 PTA APPROVED MODEL **PROD Label (After)**  J30628-003 Intel® Model: 8265NGW T P/N: G86C0007J810 SPS : XXXXXX-XXX XX WFM: OOOOOOXXXXXX BDM: OOOOOOXXXXXX FCC ID: XXXXXXXXX MM: XXXXXX TA: J29902-008 FRU P/N: 01AX705 EC: 273850 MAIN 2 AUX 1 8SPPPPPPPPPP HHHHYMDSSSS Made in China IC :1000M-8265NG Anatel: 03877-16-02198 PTA APPROVED MODEL **DISTI Label (Before)** 8265.NGWMG.NVS VERSION #: J29902-007 MADE IN CHINA WITH PARTIAL FOREIGN CONTENT CARTON #: VVXXXXXXXX MM#: XXXXXX QTY: 100 PACK DATE: DD MMM YY PACKED BY: XXXXXX BATCH #: CCVVYMDRSS Intel® Dual Band Wireless-AC 8265 (Model: 8265NGW) D P/N: PPPPPP REV AXX HP P/N: XXXXXX-XXX REV: XX L P/N: SW10K97455 EC: 273850 **DISTI Label (After)** 8265.NGWMG.NVS VERSION #: J29902-008 MADE IN CHINA WITH PARTIAL FOREIGN CONTENT CARTON #: VVXXXXXXXX MM#: XXXXXX QTY: 100 PACK DATE: DD MMM YY PACKED BY: XXXXXX BATCH #: CCVVYMDRSS Intel® Dual Band Wireless-AC 8265 (Model: 8265NGW) D P/N: PPPPPP REV AXX HP P/N: XXXXXX-XXX REV: XX L P/N: SW10K97455 EC: 273850

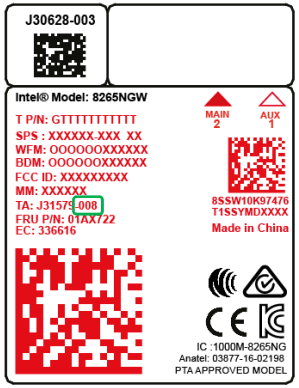
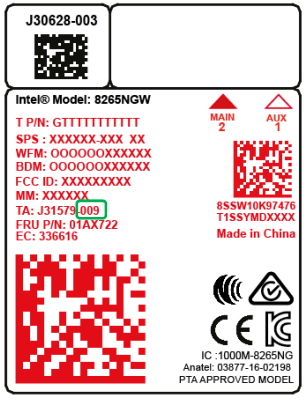
8265.NGWMG.K

PROD Label (Before)

PROD Label (After)

DISTI Label (Before)

DISTI Label (After)

8265.NGWMG.NVK	**PROD Label (Before)**  J30628-003 Intel® Model: 8265NGW T P/N: GTTTTTTTTTT SPS : XXXXXX-XXX XX WFM: OOOOOOXXXXXX BDM: OOOOOOXXXXXX FCC ID: XXXXXXXXX MM: XXXXXX TA: J31579-008 FRU P/N: 01AX722 EC: 336616 MAIN 2 AUX 1 8SSW10K97476 T1SSYMDXXXX Made in China IC :1000M-8265NG Anatel: 03877-16-02198 PTA APPROVED MODEL **PROD Label (After)**  J30628-003 Intel® Model: 8265NGW T P/N: GTTTTTTTTTT SPS : XXXXXX-XXX XX WFM: OOOOOOXXXXXX BDM: OOOOOOXXXXXX FCC ID: XXXXXXXXX MM: XXXXXX TA: J31579-009 FRU P/N: 01AX722 EC: 336616 MAIN 2 AUX 1 8SSW10K97476 T1SSYMDXXXX Made in China IC :1000M-8265NG Anatel: 03877-16-02198 PTA APPROVED MODEL **DISTI Label (Before)** 8265.NGWMG.NVK VERSION #: J31579-008 MADE IN CHINA WITH PARTIAL FOREIGN CONTENT CARTON #: VVXXXXXXXX MM#: XXXXXX QTY: 100 PACK DATE: DD MMM YY PACKED BY: XXXXXX BATCH #: CCVVYMDRSS 1 88334 00140 2 9 310779 300005 Intel® Dual Band Wireless-AC 8265 (Model: 8265NGW) PKG ID (3S) VVVVVMMMMMDDD######PPPPPP100 T P/N: GTTTTTTTTTT D P/N: XXXXXX REV AXX HP P/N: XXXXXX-XXX REV: XX PACKAGE WEIGHT: XX LBS Vendor ID | Loc Id VVVVVLLLLL Mfg Id MMMMM L P/N: SW10K97476 EC: 336616 Intel Corporation 2200 Mission College Blvd Santa Clara, CA 95054-1549 USA www.intel.com CMIIT ID: 2016AJ2775 (M) MSIP-CRM-INT-8265NGW **DISTI Label (After)** 8265.NGWMG.NVK VERSION #: J31579-009 MADE IN CHINA WITH PARTIAL FOREIGN CONTENT CARTON #: VVXXXXXXXX MM#: XXXXXX QTY: 100 PACK DATE: DD MMM YY PACKED BY: XXXXXX BATCH #: CCVVYMDRSS 1 88334 00140 2 9 310779 300005 Intel® Dual Band Wireless-AC 8265 (Model: 8265NGW) PKG ID (3S) VVVVVMMMMMDDD######PPPPPP100 T P/N: GTTTTTTTTTT D P/N: XXXXXX REV AXX HP P/N: XXXXXX-XXX REV: XX PACKAGE WEIGHT: XX LBS Vendor ID | Loc Id VVVVVLLLLL Mfg Id MMMMM L P/N: SW10K97476 EC: 336616 Intel Corporation 2200 Mission College Blvd Santa Clara, CA 95054-1549 USA www.intel.com CMIIT ID: 2016AJ2775 (M) MSIP-CRM-INT-8265NGW

8265.NGWMG.DTX1	**PROD Label – Child TA (Before)** **PROD Label – Child TA (After)** **DISTI Label – Child TA (Before)** **DISTI Label – Child TA (After)**

Customer Impact of Change and Recommended Action:

The label changes to the products do not affect functionality. Intel anticipates no impact to customers.

Intel will attempt to deplete pre-conversion material before shipping post-conversion material but there is a possibility of Intel shipping mixed inventory. Therefore, customers will need to manage and migrate to the post-conversion material as soon as possible.

Milestone dates are estimates and subject to change based on business and operational conditions.

Please contact your local Intel Field Sales Rep if you have any further questions about these changes.

Products Affected / Intel Ordering Codes:

Product Code	MM#	Pre Change TA	Post Change TA
8265.NGWMG	946658	J29831-007	J29831-008
8265.NGWMG.NV	949399	J29844-007	J29844-008
8265.NGWMG.S	951075	J29895-007	J29895-008
8265.NGWMG.NVS	951076	J29902-007	J29902-008
8265.NGWMG.K	951820	J31538-008	J31538-009
8265.NGWMG.NVK	951821	J31579-008	J31579-009
8265.NGWMG.DTX1	958156	J29831-007	J29831-008

PCN Revision History:

Date of Revision:	Revision Number:	Reason:
March 4, 2019	00	Originally Published PCN

Product Change Notification
116801 - 00

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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